

## 限用物質含有情況標示聲明書 Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱: 鑽石鑽孔機 ,型號(型式):DD 160 Equipment name Type designation (Type)						
	限用物質及其化學符號 Restricted substances and its chemical symbols					
單元Unit	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr <sup>+6</sup> )	多溴聯苯 Polybrominate d biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
電子原件 (電路版,開關,電 線) Electronics (pcb, switch, wiring)	_	0	Ι	0	0	0
馬達 Motor	_	0	0	0	0	0
電源線 Power cord	_	0	0	0	0	0
緊固元件 Fastener elements	0	0	0	0	0	0
金屬部件 Metal parts	_	0	0	0	0	0
電源供應系統 Power supplies	_	0	0	0	0	0
<ul> <li>備考1. "超出0.1 wt%"及"超出0.01 wt%" 係指限用物質之百分比含量超出百分比含量基準值。</li> <li>Note 1: "Exceeding 0.1 wt%" and "exceeding 0.01 wt%" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.</li> <li>備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值。</li> <li>Note 2: "o" indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.</li> <li>備考3. "一" 係指該項限用物質為排除項目。</li> <li>Note 3: The "-" indicates that the restricted substance corresponds to the exemption.</li> </ul>						